746610-3 - ACTIVE

AMP-LATCH

TE Internal #: 746610-3 Ribbon Cable Connectors, Wire-to-Board, 16 Position, .1 in [2.54 mm] Centerline, Vertical, Through Hole - Solder, Insulation Displacement (IDC), 2 Row

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Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors



Connector System: Wire-to-Board

Number of Positions: 16

Centerline (Pitch): 2.54 mm [.1 in]

PCB Mount Retention: Without

PCB Mount Orientation: Vertical

Features

TE

Product Type Features

Connector Type	Connector Assembly
Ribbon Cable Connector Header Type	Pin Header
Connector Product Type	Connector Assembly
Connector System	Wire-to-Board
Connector & Housing Type	Plug
Connector & Contact Terminates To	Printed Circuit Board, Wire & Cable
Configuration Features	
Number of Positions	16
PCB Mount Orientation	Vertical
Number of Rows	2
Electrical Characteristics	
UL Voltage Rating	250 VAC
Insulation Resistance	5000 MΩ
Operating Voltage	250 VAC

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Body Features

Daisy Chain	Without	
Connector Profile	Standard	
Contact Features		
Contact Layout	Inline	
PCB Contact Termination Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]	
Contact Type	Pin	
Wire Contact Termination Area Plating Thickness	2.54 – 5.08 μm[100 – 200 μin]	
Wire Contact Termination Area Plating Material	Tin	
Contact Mating Area Plating Material Thickness	2.54 μm[100 μin]	
PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Phosphor Bronze	
Contact Current Rating (Max)	1 A	
Termination Features		
Rectangular Termination Post & Tail Thickness	.32 mm[.013 in]	
Rectangular Termination Post & Tail Width	.5 mm[.02 in]	
Termination Post & Tail Length	3.96 mm[.156 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Termination Method to Wire & Cable	Insulation Displacement (IDC)	
Mechanical Attachment		
Mating Alignment	With	
PCB Mount Alignment	Without	
Panel Mount Feature	Without	
PCB Mount Retention	Without	
Mating Alignment Type	Polarization	
Mating Retention	Without	
Connector Mounting Type	Board Mount	
Housing Features		
Housing Material	Thermoplastic	
Housing Color	Black	
Centerline (Pitch)	2.54 mm[.1 in]	
Dimensions		

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Connector Length	24.89 mm[.98 in]
Connector Height	6.43 mm[.253 in]
Connector Width	7.06 mm[.278 in]
Wire Size	.051 – .15 mm²
PCB Thickness (Recommended)	3.18 mm[.125 in]
Accepts Wire Insulation Diameter Range	.81 – 1.07 mm[.032 – .042 in]
Row-to-Row Spacing	2 mm[.1 in]
Usage Conditions	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Solder Dipped
Circuit Application	Signal
ndustry Standards	
CSA File Number	LR 7189
UL Rating	Recognized
Agency/Standard	CSA, UL
UL File Number	E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	50
Packaging Method	Box & Tube, Tube
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.

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Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Customers Also Bought



Documents

Product Drawings 016 DIP PLUG 100CL TIN

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English	
CAD Files	
3D PDF	
3D	
Customer View Model	
ENG_CVM_CVM_746610-3_F.2d_dxf.zip	
English	
Customer View Model	
ENG_CVM_CVM_746610-3_F.3d_igs.zip	
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Customer View Model	
ENG_CVM_CVM_746610-3_F.3d_stp.zip	
English	
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Product Specifications	
Application Specification	
English	
Instruction Sheets	
Instruction Sheet (U.S.)	
English	

Agency Approvals Agency Approval Document



English